

/ Descriptions

TO-252 N MOS

N-CHANNEL MOSFET in a TO-252 Plastic Package.

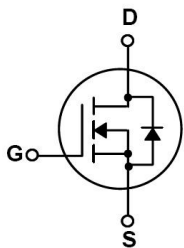
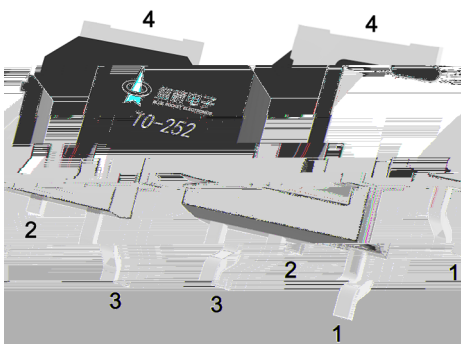
/ Features $V_{DS}=500V$ $I_D=7A$ $R_{DS(ON)}@10V \leq 1.5\Omega$ (Typ. 1.2Ω)

Fast Switching.

HF Product.

/ Applications

These devices are well suited for power switch circuit of adaptor and charger, intergrate fast recovery diode.

/ Equivalent Circuit**/ Pinning**

PIN1 G

PIN 2 D

PIN 3 S

PIN 4 D

/ Marking

See Marking Instructions.

/ Absolute Maximum Ratings(Ta=25)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	500	V
Drain Current	$I_D(T_c=25^\circ\text{C})$	7	A
Drain Current - Pulsed	I_{DM}	28	A
Gate-Source Voltage	V_{GS}	± 30	V
Single Pulsed Avalanche Energy	E_{AS}	392	mJ
Avalanche Current	I_{AS}	8.4	A
Power Dissipation	$P_D(T_c=25^\circ\text{C})$	50	W
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to 150	
Junction to Ambient	$R_{\theta JA}$	110	/W
Junction to Case	$R_{\theta JC}$	2.5	/W

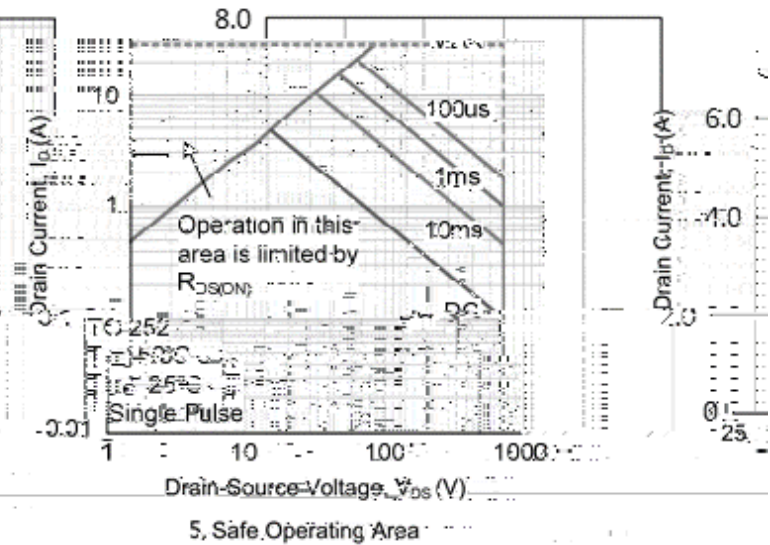
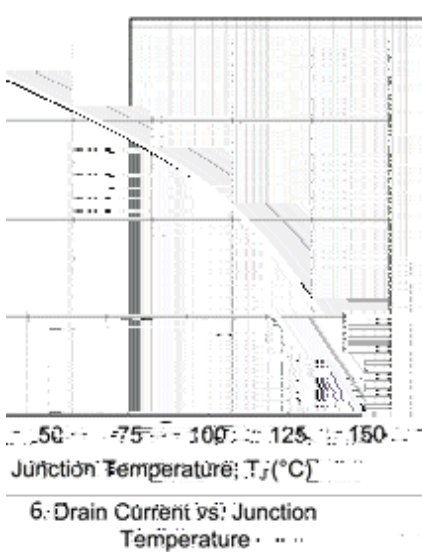
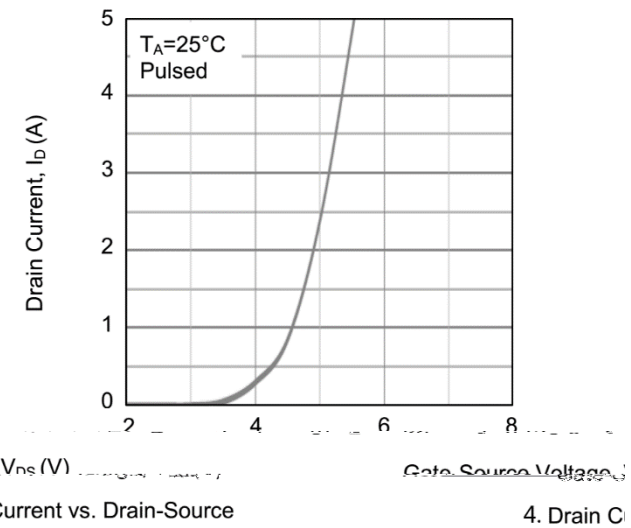
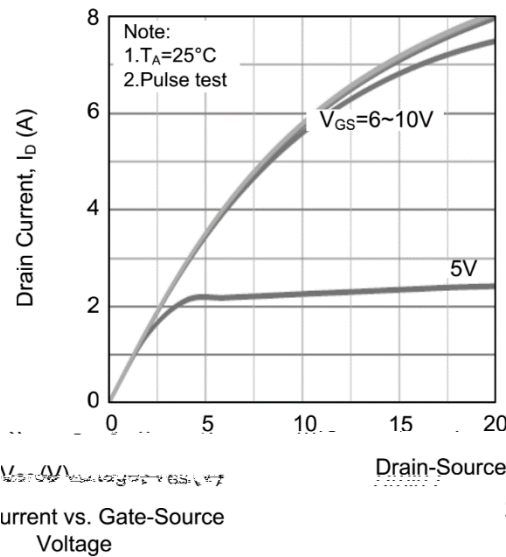
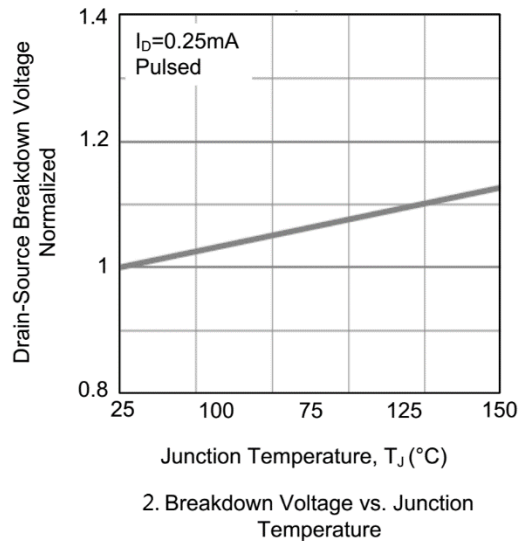
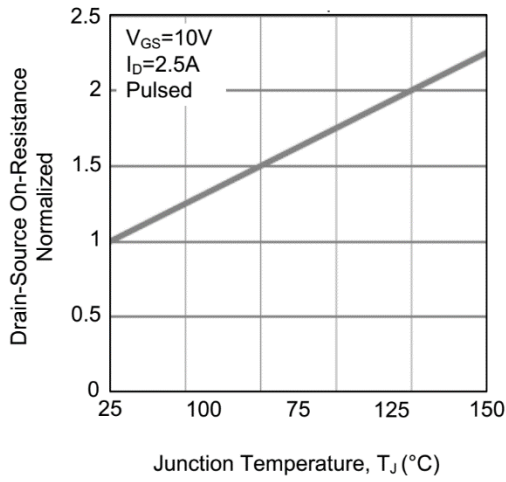
/ Electrical Characteristics(Ta=25)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV_{DS}	$V_{GS}=0V$ $I_D=250\mu A$	500	554		V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=500V$ $V_{GS}=0V$			1	μA
Gate-Body Leakage Current Forward	I_{GSS}	$V_{GS}=\pm 30V$ $V_{DS}=0V$			± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ $I_D=250\mu A$	2.0	2.9	4.0	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V$ $I_D=3.0A$		1.2	1.5	Ω
Drain-Source Diode Forward Voltage	V_{SD}	$V_{GS}=0V$ $I_S=1.0A$			1.4	V
Input Capacitance	C_{iss}	$V_{DS}=25V$ $V_{GS}=0V$ $f=1.0MHz$		570		pF
Output Capacitance	C_{oss}			62		
Reverse Transfer Capacitance	C_{rss}			5.5		
Total Gate Charge	Q_G	$V_{DS}=400V$ $I_D=7.0A$ $V_{GS}=10V$		30		nC
Gate-Source Charge	Q_{GS}			12.5		
Gate-Drain Charge	Q_{GD}			5.4		

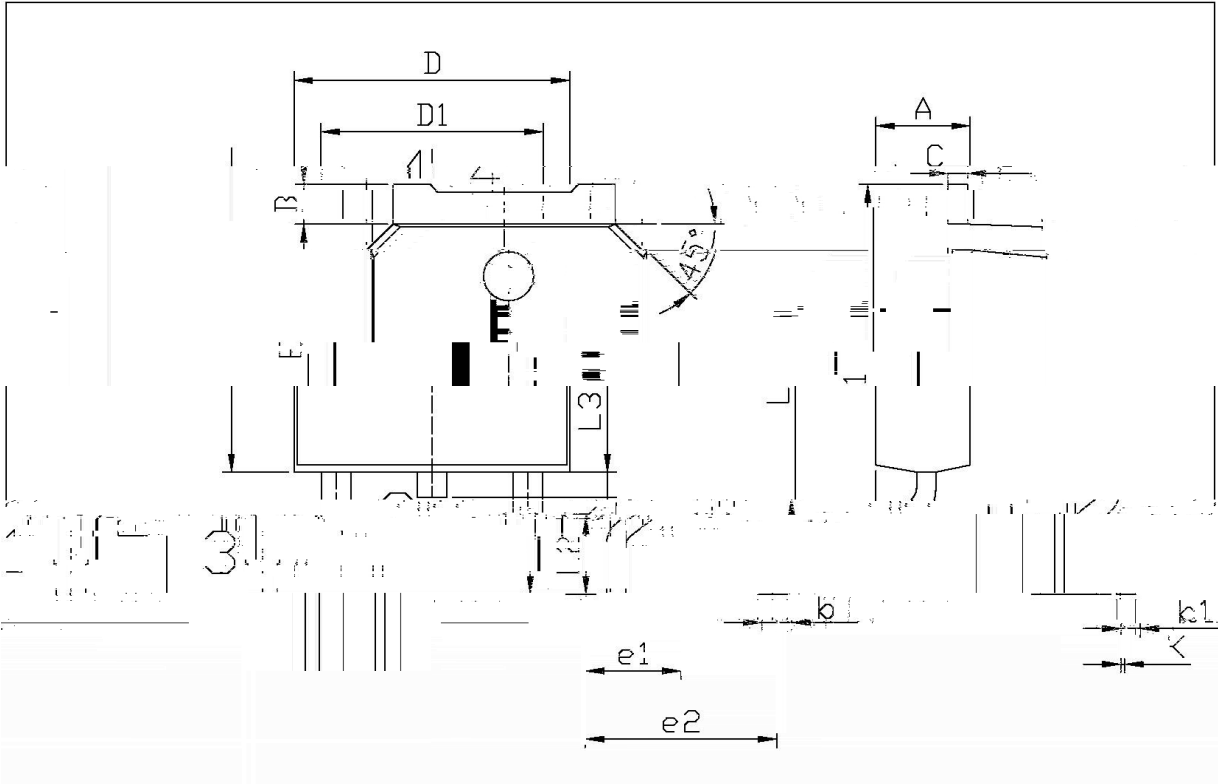
/ Electrical Characteristics(Ta=25)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=100V$ $I_D=7.0A$ $V_{GS}=10V$ $R_G=25\Omega$		11		ns
Turn-On Rise Time	t_r			17.5		
Turn-Off Delay Time	$t_{d(off)}$			53		
Turn-Off Fall Time	t_f			32		
Maximum Continuous Drain-Source Diode Forward Current	I_S				7	A
Maximum Pulsed Drain-Source Diode Forward Current	I_{SM}				28	A
Reverse Recovery Time	t_{rr}	$V_{GS}=0V$ $I_S=7.0A$ $dI_F/dt=100 A/\mu s$		90		ns
Reverse Recovery Charge	Q_{rr}			250		nC

/ **Electrical Characteristic Curve**



/ Package Dimensions

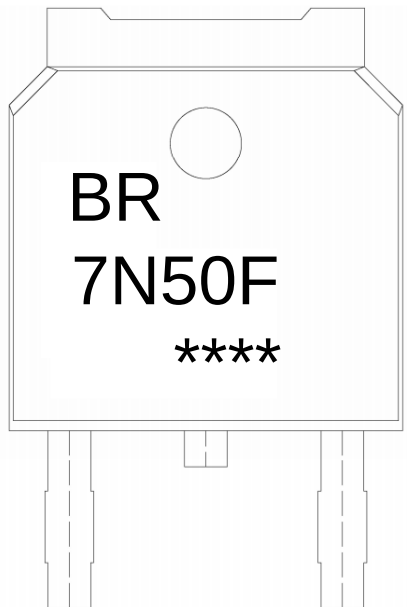


单位: mm

Symbol		Dimensions In Millimeters		Symbol		Dimensions In Millimeters	
		Min	Max			Min	Max
A	5.95	6.25	6.75	B	2.20	2.40	2.60
B	0.95	1.25	1.55	C	2.24	2.34	2.44
C	0.70	0.80	0.90	D	4.42	4.73	5.04
D	0.45	0.55	0.65	E	9.85	10.35	10.85
E	0.90	1.00	1.10	L1	0.55	0.70	0.85
L1	0.90	1.00	1.10	L2	6.45	6.75	7.05
L2	0.10	0.20	0.30	L3	5.10	5.50	5.90
L3	0.10	0.20	0.30	k	0.60	0.70	0.80

TO-252

/ Marking Instructions



BR

7N50F

Note:

BR: Company Code

7N50F: Product Type Code

****: Lot No. Code, code change with Lot No

() / Temperature Profile for IR Reflow Soldering(Pb-Free)

- Note:
- 1

150 180

60 90sec;

2

245±5

5±0.5sec;

3

2 10 /sec.
- 1.Preheating:150~180 , Time:60~90sec.

2.Peak Temp.:245±5 , Duration:5±0.5sec.

3. Cooling Speed: 2~10 /sec.

/ Resistance to Soldering Heat Test Conditions

260±5 10±1 sec. Temp.:260±5℃ Time:10±1 sec

/ Packaging SPEC.

/ REEL

Package Type	Units					Dimension (unit mm ³)		
	Units/Reel /	Reels/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Reel	Inner Box	Outer Box